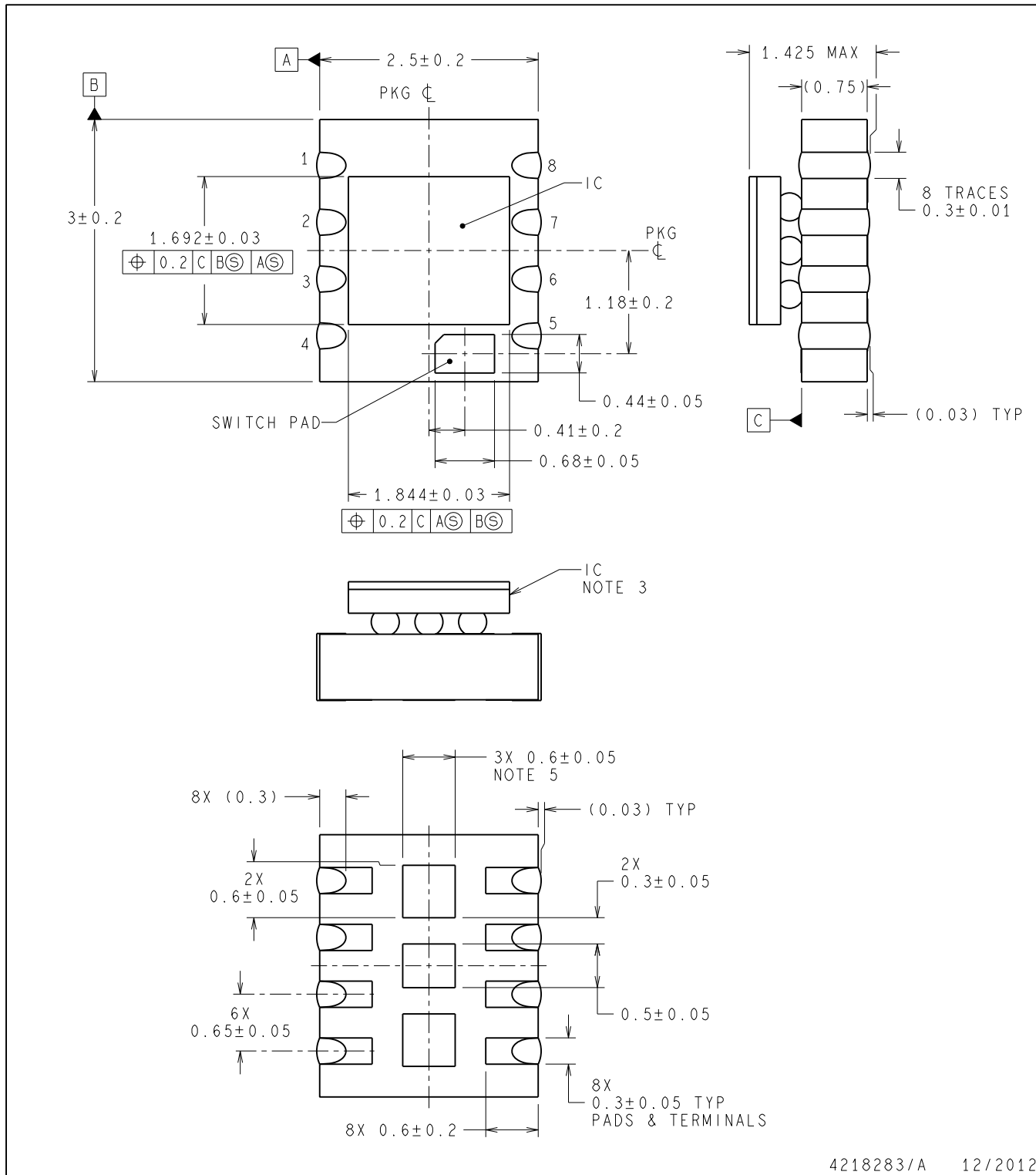


NQB0008A

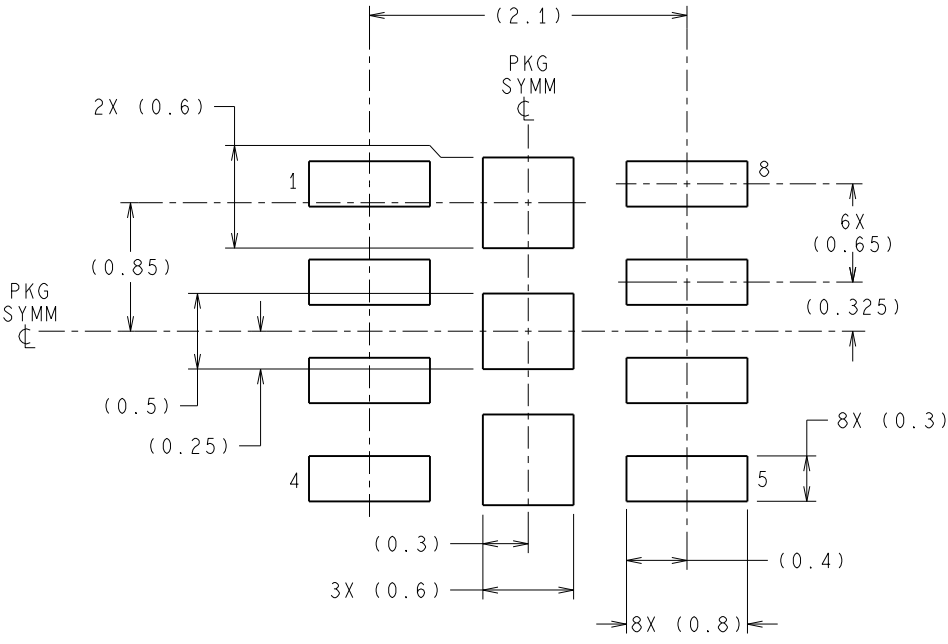
POS - 1.425 mm max pkg height

POS

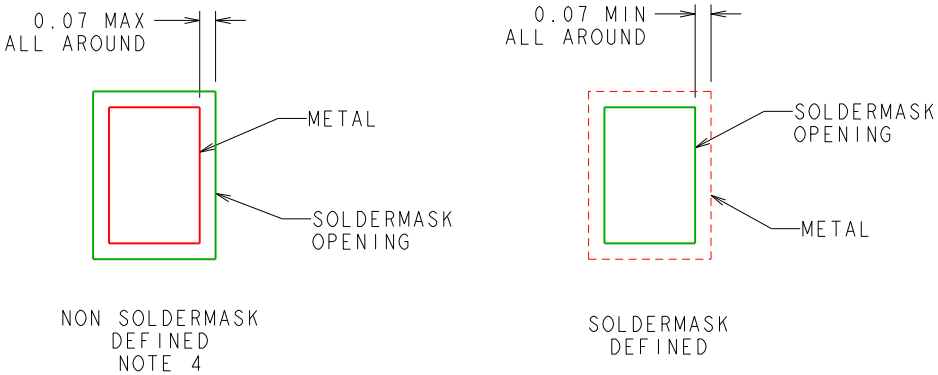


4218283/A 12/2012

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 2. THIS DRAWING IS SUBJECT TO CHANGE WITHOUT NOTICE.
 3. DSBGA ON LTCC.
 4. RECOMMEND NON-SOLDER MASK DEFINED LANDING PAD.
 5. CENTER PADS MUST BE SOLDERED TO THE PCB FOR MECHANICAL PERFORMANCE.



RECOMMENDED LAND PATTERN



SOLDERMASK DETAILS NOT TO SCALE

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